imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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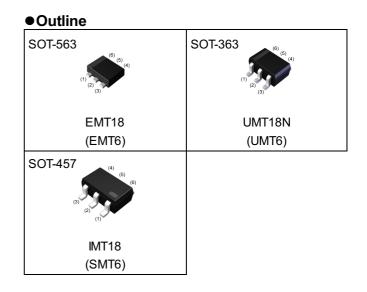
EMT18 / UMT18N / IMT18

General purpose transistor (dual transistor)

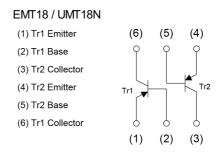
| Parameter | Tr1 and Tr2 |
|------------------|-------------|
| V _{CEO} | -12V |
| ۱ _C | -500mA |

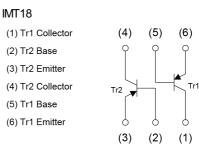
Features

- 1)Two 2SA2018 chips in a EMT or UMT or SMT package.
- 2)Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.



Inner circuit





Application

LOW FREQUENCY AMPLIFIER, DRIVER

Packaging specifications

| · · · · · · · · · · · · · · · · · · · | | | | | | | |
|---------------------------------------|-------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
| EMT18 | SOT-563 (EMT6) | 1616 | T2R | 180 | 8 | 8000 | T18 |
| UMT18N | SOT-363 (UMT6) | 2021 | TR | 180 | 8 | 3000 | T18 |
| IMT18 | SOT-457 (SMT6) | 2928 | T110 | 180 | 8 | 3000 | T18 |

• Absolute maximum ratings (T_a = 25°C)

<It is the same ratings for the Tr1 and Tr2>

| Parameter | | | Values | Unit |
|------------------------------|---------------|--------------------------------|-------------|---------|
| Collector-base voltage | | | -15 | V |
| Collector-emitter voltage | | | -12 | V |
| Emitter-base voltage | | | -6 | V |
| Collector current | | Ι _C | -500 | mA |
| | | I _{CP} *1 | -1.0 | Α |
| | EMT18/ UMT18N | P _D ^{*2*3} | 150 | mW/Tota |
| Power dissipation | IMT18 | P _D ^{*2*4} | 300 | mW/Tota |
| Junction temperature | | | 150 | °C |
| Range of storage temperature | | | -55 to +150 | °C |

•Electrical characteristics (T_a = 25°C)

< It is the same characteristics for the Tr1 and Tr2>

| Parameter | Symbol | Conditions | Values | | | Unit | |
|--|----------------------|---|--------|------|------|------|--|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Unit | |
| Collector-base breakdown voltage | BV_{CBO} | BV _{CBO} Ι _C = -10μΑ | | - | - | V | |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -12 | - | - | V | |
| Emitter-base breakdown voltage | BV_{EBO} | Ι _Ε = -10μΑ | -6 | - | - | V | |
| Collector cut-off current | I _{CBO} | V _{CB} = -15V | - | - | -100 | nA | |
| Emitter cut-off current | I _{EBO} | V _{EB} = -6V | - | - | -100 | nA | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = -200mA, I _B = -10mA | - | -100 | -250 | mV | |
| DC current gain | h _{FE} | V _{CE} = -2V, I _C = -10mA | 270 | - | 680 | - | |
| Transition frequency | f⊤ | V _{CE} = -2V, I _E = 10mA, f = 100MHz | - | 260 | - | MHz | |
| Output capacitance | | V _{CB} = -10V, I _E = 0A, f = 1MHz | - | 6.5 | - | pF | |

*1 Pw=1ms Single Pulse

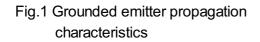
*2 Each terminal mounted on a reference land.

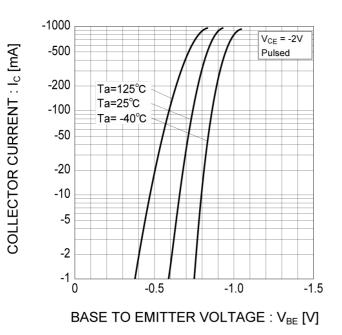
- *3 120mW per element must not be exceeded.
- *4 200mW per element must not be exceeded.

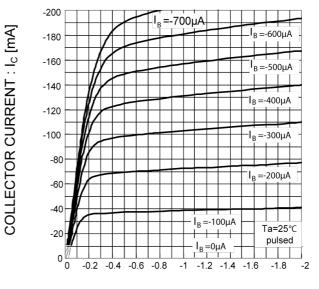


• Electrical characteristic curves (T_a = 25°C)

<For Tr1 and Tr2 in common>







COLLECTOR TO EMITTER VOLTAGE : $V_{\text{CE}}\left[V\right]$

Fig.3 DC current gain vs. collector current (I)

Fig.4 DC current gain vs. collector current (II)

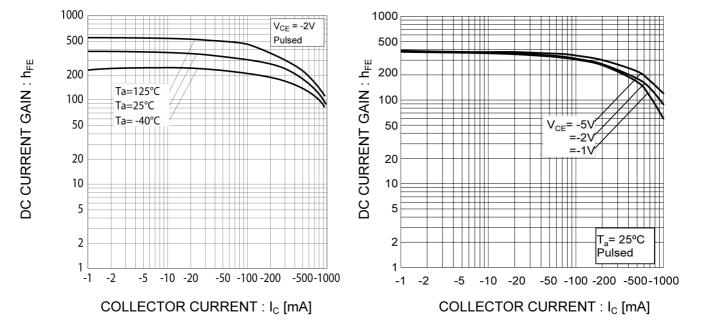
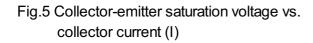
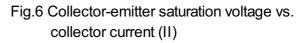


Fig.2 Typical output characteristics

•Electrical characteristic curves (T_a = 25°C)

<For Tr1 and Tr2 in common>





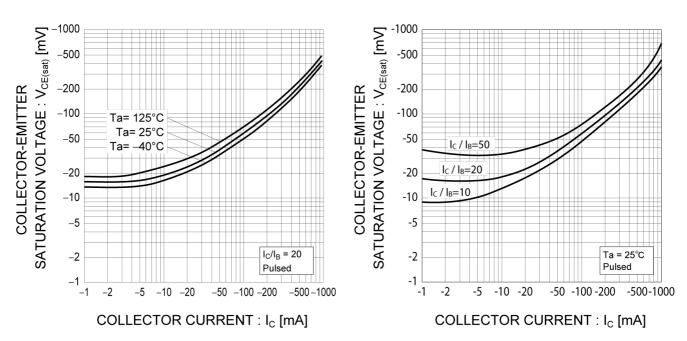
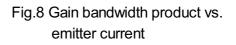
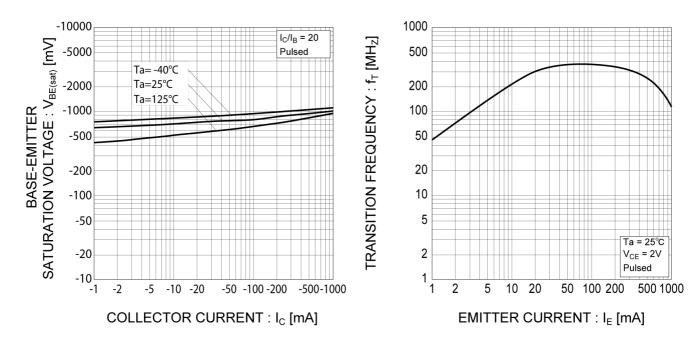


Fig.7 Base-emitter saturation voltage vs. collector current







•Electrical characteristic curves (T_a =25°C)

<For Tr1 and Tr2 in common>

Fig.9 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage

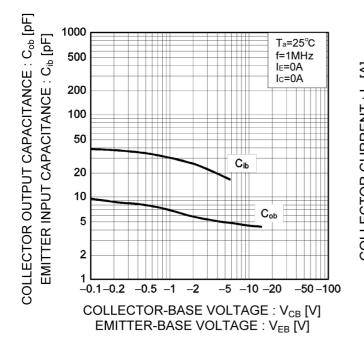


Fig.10 Safe Operating Area

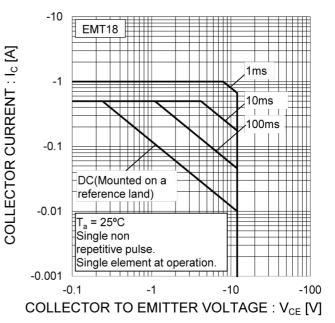


Fig.11 Safe Operating Area

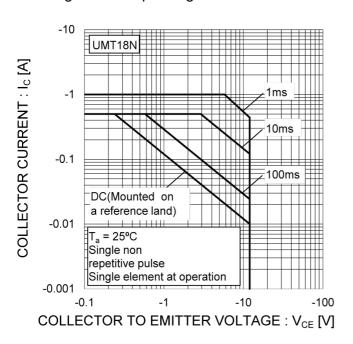
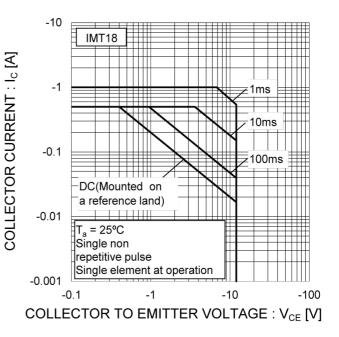
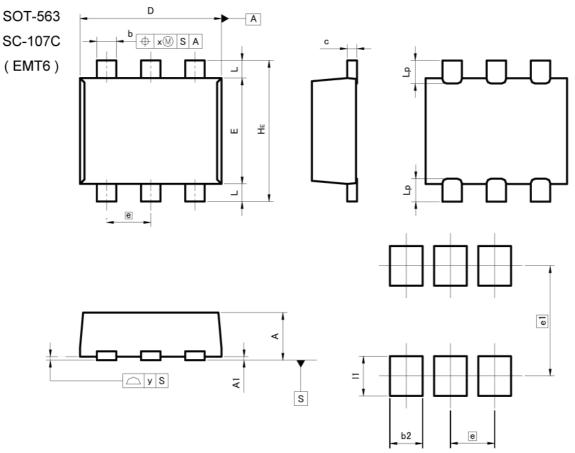


Fig.12 Safe Operating Area



Dimensions



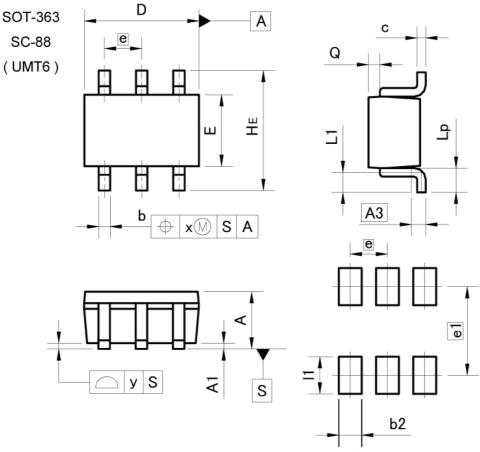
Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INCHES | | |
|-------|-------|-------|----------------|-------|--|
| | MIN | MAX | MIN | MAX | |
| A | 0.45 | 0.55 | 0.018 | 0.022 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| b | 0.17 | 0.27 | 0.007 | 0.011 | |
| с | 0.08 | 0.18 | 0.003 | 0.007 | |
| D | 1.50 | 1.70 | 0.059 | 0.067 | |
| E | 1.10 | 1.30 | 0.043 | 0.051 | |
| е | 0. | 0.50 | | 0.020 | |
| HE | 1.50 | 1.70 | 0.059 | 0.067 | |
| L | 0.10 | 0.30 | 0.004 | 0.012 | |
| Lp | | 0.35 | - | 0.014 | |
| x | _ | 0.10 | - | 0.004 | |
| у | = | 0.10 | | 0.004 | |
| | MILIM | ETERS | INC | HES | |
| DIM - | MIN | MAX | MIN | MAX | |
| b2 | | 0.37 | - | 0.015 | |
| e1 | 1. | 25 | 0.049 | | |
| 11 | | 0.45 | 1 4 | 0.018 | |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DINA | MILIM | ETERS | INC | HES |
|------|------------|-------|----------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0.25 | | 0.0 | 10 |
| b | 0.15 | 0.30 | 0.006 | 0.012 |
| С | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 1.90 | 2.10 | 0.075 | 0.083 |
| E | 1.15 | 1.35 | 0.045 | 0.053 |
| е | 0. | 0.65 | | 26 |
| HE | 2.00 | 2.20 | 0.079 | 0.087 |
| L1 | 0.20 | 0.50 | 0.008 | 0.020 |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 |
| Q | 0.10 | 0.30 | 0.004 | 0.012 |
| x | | 0.10 | 32 | 0.004 |
| У | - | 0.10 | | 0.004 |
| | MILIMETERS | | INC | HES |
| | MIN | MAX | MIN | MAX |
| b2 | -3 | 0.40 | | 0.016 |
| e1 | 1. | 55 | 0.0 | 61 |

Dimension in mm/inches

 \overline{a}

11

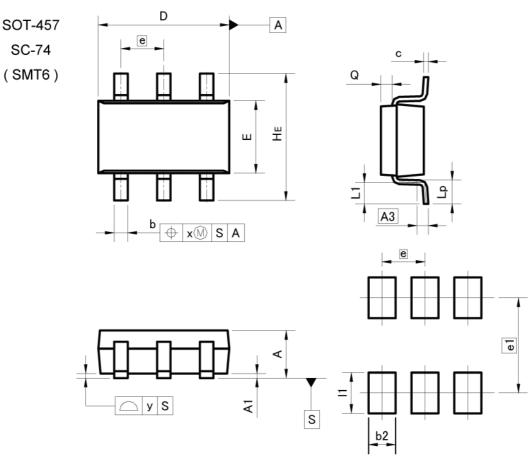


0.026

0.65

-

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| | MILIM | ETERS | INCHES | | |
|----|------------------|-------|----------|-------|--|
| | MIN | MAX | MIN | MAX | |
| A | 1.00 | 1.30 | 0.039 | 0.051 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| A3 | 0. | 0.25 | | 10 | |
| b | 0.25 | 0.40 | 0.010 | 0.016 | |
| с | 0.09 | 0.25 | 0.004 | 0.010 | |
| D | 2.80 | 3.00 | 0.110 | 0.118 | |
| E | 1.50 | 1.80 | 0.059 | 0.071 | |
| е | 0.95 | | 0.037 | | |
| HE | 2.60 | 3.00 | 0.102 | 0.118 | |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 | |
| Lp | 0.40 | 0.70 | 0.016 | 0.028 | |
| Q | 0.20 | 0.30 | 0.008 | 0.012 | |
| x | 22 66 | 0.20 | TT S | 0.008 | |
| у | | 0.10 | — | 0.004 | |

| DIM | MILIM | ETERS | INCHES | |
|-----|-------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | | 0.60 | | 0.024 |
| e1 | 2.10 | | 0.083 | |
| 11 | =8 | 0.90 | | 0.035 |

Dimension in mm/inches



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| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JAPAN | USA | EU | CHINA |
|--------|----------|------------|---------|
| CLASSⅢ | CLASSⅢ | CLASS II b | |
| CLASSⅣ | CLASSIII | CLASSⅢ | CLASSII |

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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